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-0 2

## **ESD Protection Diode**

### Micro-Packaged Diodes for ESD Protection

## **ESDL2011**

The ESDL2011 is designed to protect voltage sensitive components that require low capacitance from ESD and transient voltage events. Excellent clamping capability, low capacitance, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its low capacitance, the part is well suited for use in high speed data line applications.

#### Features

- Low Capacitance 0.17 pF (Typ)
- Low Clamping Voltage
- Small Body Outline Dimensions: 0.60 mm x 0.30 mm
- Low Body Height: 0.2 mm
- Stand-off Voltage: 1.0 V
- IEC61000-4-2 Level 4 ESD Protection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Typical Applications**

- USB 3.x
- Thunderbolt 3.0

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Contact Air		±15 ±15	kV
Total Power Dissipation on FR-4 Board (Note 1) @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction-to-Ambient	P <sub>D</sub> R <sub>θJA</sub>	313 400	mW °C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Lead Solder Temperature – Maximum (10 Second Duration)	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 = 28 mm<sup>2</sup> 1 oz. Cu JEDEC JESD51-3 two layer PCB.

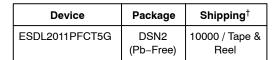
See Application Note AND8308/D for further description of survivability specs.



10

A = Specific Device Code

#### **ORDERING INFORMATION**

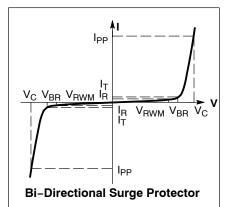


+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **ELECTRICAL CHARACTERISTICS**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Symbol	Parameter
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
V <sub>C</sub>	Clamping Voltage @ IPP
V <sub>RWM</sub>	Working Peak Reverse Voltage
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>
Ι <sub>Τ</sub>	Test Current



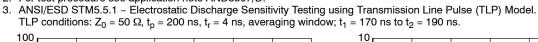
\*See Application Note AND8308/D for detailed explanations of datasheet parameters.

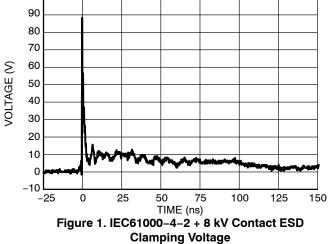
#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise specified)

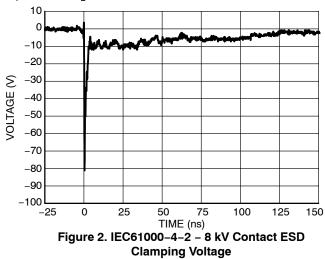
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V <sub>RWM</sub>	I/O Pin to GND			1.0	V
Breakdown Voltage	V <sub>BR</sub>	I <sub>T</sub> = 1 mA, I/O Pin to GND	1.4	1.65	2.3	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 1.0 V		30	500	nA
Clamping Voltage (Note 2)	V <sub>C</sub>	IEC61000-4-2, ±8 kV Contact	Figures 1 and 2		2	V
Clamping Voltage 200 ns TLP	V <sub>C</sub>	$I_{PP} = 4 A $ $\begin{cases} IEC61000-4-2 \text{ Level 1 Equivalent} \\ (\pm 2 \text{ kV Contact, } \pm 4 \text{ kV Air}) \end{cases}$		3.5	4.0	V
		$I_{PP} = 8 A \\ \begin{cases} IEC61000-4-2 \text{ Level 2 Equivalent} \\ (\pm 4 \text{ kV Contact, } \pm 8 \text{ kV Air}) \end{cases}$		4.8	6.0	
Reverse Peak Pulse Current per Figure 12	I <sub>PP</sub>	per IEC61000–4–5 (1.2/50 µs), R <sub>eq</sub> = 12 $\Omega$	3.5	4.5		А
Clamping Voltage 1.2/50 μs Waveform per Figure 12	V <sub>C</sub>	$I_{PP}$ = 2.1 A, IEC61000–4–5 (1.2/50 μs), R <sub>eq</sub> = 12 Ω		2.9	3.5	V
Clamping Voltage 1.2/50 μs Waveform per Figure 12	V <sub>C</sub>	I <sub>PP</sub> = 3.5 A, IEC61000–4–5 (1.2/50 μs), R <sub>eq</sub> = 12 Ω		3.6	4.0	V
Dynamic Resistance (TLP)	R <sub>DYN</sub>	I/O Pin to GND (4 A to 8 A, 200 ns TLP)		0.34	0.5	Ω
Junction Capacitance	CJ	V <sub>R</sub> = 0 V, f = 1 MHz		0.17	0.20	pF
Insertion Loss	۱ <sub>L</sub>	f = 5 GHz f = 10 GHz		0.165 0.34	0.20 0.40	dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. For test procedure see application note AND8307/D.







#### ESDL2011

#### **TYPICAL CHARACTERISTICS**

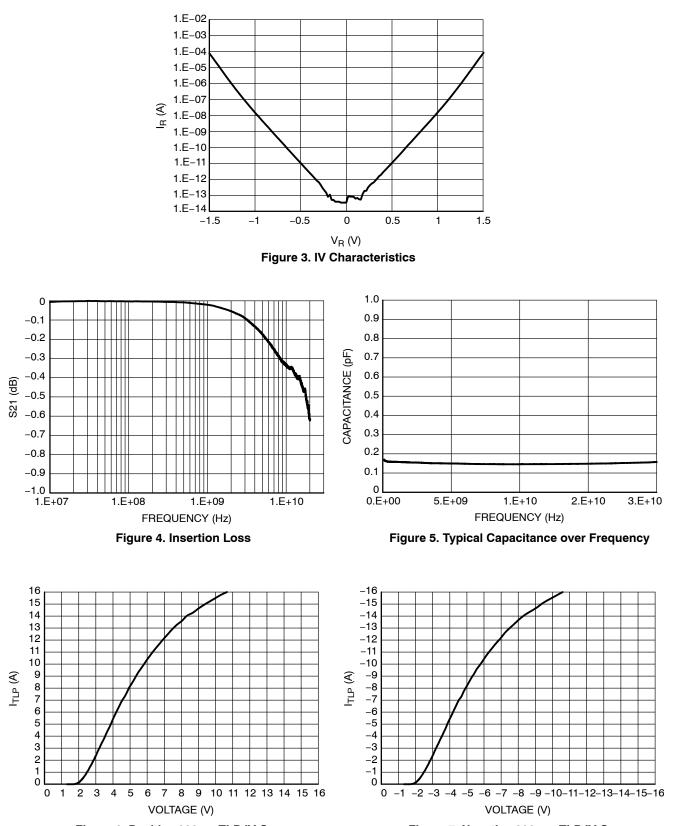


Figure 6. Positive 200 ns TLP IV Curve

Figure 7. Negative 200 ns TLP IV Curve

#### ESDL2011

#### **TYPICAL CHARACTERISTICS**

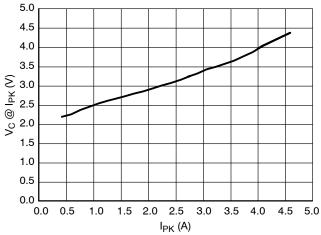


Figure 8. Positive Clamping Voltage vs. Peak Pulse Current (per IEC61000–4–5 (t\_p = 1.2/50  $\mu s,\,R_{eq}$  = 12  $\Omega))$ 

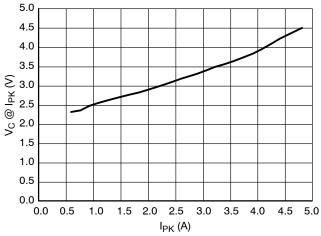


Figure 9. Negative Clamping Voltage vs. Peak Pulse Current (per IEC61000–4–5 (t\_p = 1.2/50  $\mu s,\,R_{eq}$  = 12  $\Omega))$ 

#### IEC 61000-4-2 Spec.

Level	Test Volt- age (kV)	First Peak Current (A)	Current at 30 ns (A)	Current at 60 ns (A)
1	2	7.5	4	2
2	4	15	8	4
3	6	22.5	12	6
4	8	30	16	8

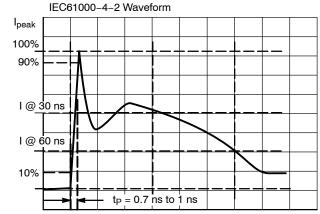


Figure 10. IEC61000-4-2 Spec

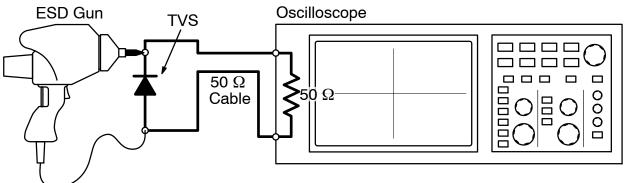


Figure 11. Diagram of ESD Test Setup

#### **ESD Voltage Clamping**

For sensitive circuit elements it is important to limit the voltage that an IC will be exposed to during an ESD event to as low a voltage as possible. The ESD clamping voltage is the voltage drop across the ESD protection diode during an ESD event per the IEC61000–4–2 waveform. Since the IEC61000–4–2 was written as a pass/fail spec for larger systems such as cell phones or laptop computers it is not

clearly defined in the spec how to specify a clamping voltage at the device level. **onsemi** has developed a way to examine the entire voltage waveform across the ESD protection diode over the time domain of an ESD pulse in the form of an oscilloscope screenshot, which can be found on the datasheets for all ESD protection diodes. For more information on how **onsemi** creates these screenshots and how to interpret them please refer to AND8307/D.

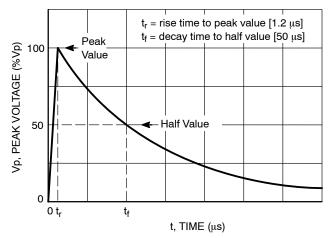
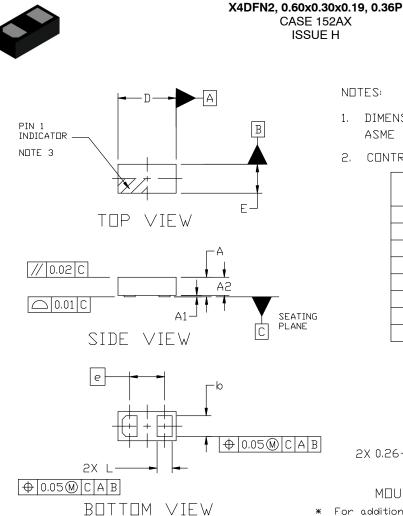


Figure 12. IEC61000–4–5 1.2/50  $\mu s$  Pulse Waveform

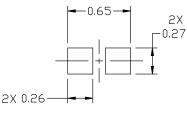
# **ISEM**

DATE 01 AUG 2023



- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETERS			
DIM	MIN.	NDM.	MAX.	
Α	0.175	0.200	0.225	
A1	0.018 REF			
A2	0.180	0.190	0.200	
b	0.205	0.215	0.225	
D	0.575	0.600	0.625	
E	0.275	0.300	0.325	
e	0.36 BSC			
L	0.145	0.155	0.165	



#### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

GENERIC **MARKING DIAGRAM\*** 



X = Specific Device Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present. Some products may not follow the Generic Marking.

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